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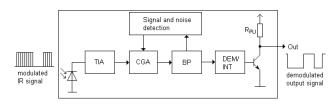


# **DATASHEET**

# Infrared Receiver Control Receiver Module EAIRMLA4



# Block Diagram



#### **Features**

- · High protection ability against EMI
- · Circular lens for improved reception characteristics
- · Available for various carrier frequencies
- · Min burst length: 10 cycles
- · Min gap length: 14 cycles
- Low operating voltage and low power consumption
- · High immunity against ambient light
- · Long reception range
- · High sensitivity
- · Pb free and RoHS compliant
- · Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

#### **Description**

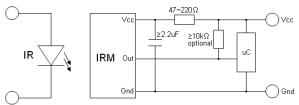
- The device is miniature SMD type infrared receiver that has been developed and designed by utilizing the latest IC technology.
- The PIN diode and preamplifier are assembled onto a lead frame and molded into an epoxy package which operated an IR filter. The demodulated output signal can directly be decoded by a microprocessor.

#### **Applications**

- · Light detecting portion of remote control
- · AV instruments such as Audio, TV, VCR, CD, MD, etc
- · Home appliances such as Air-conditioner, Fan, etc
- 0ther devices using IR remote control
- · CATV set top boxes
- Multi-media Equipment



# **Application Circuit**



## **Parts Table**

Model No.	Carrier Frequency
EAIRMLA4	40 kHz

# Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc	6	V
Operating Temperature	Topr	-20 ~ +80	$^{\circ}$ C
Storage Temperature	Tstg	-40 ~ +85	$^{\circ}\! \mathbb{C}$
Soldering Temperature *1	Tsol	260	$^{\circ}$

<sup>\*1 4</sup>mm from mold body for less than 10 seconds



# Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Current consumption	Icc	-	0.4	0.6	mA	No input signal
Supply voltage	V <sub>CC</sub>	2.7	-	5.5	V	
Peak wavelength	$\lambda_{p}$		940		nm	
Reception range	L <sub>0</sub>	8			m	See chapter ,Test method'
	L <sub>45</sub>	5				
Half angle(horizontal)	$\phi_{h}$		±45		deg	
Half angle(vertical)	$\phi_{\text{v}}$		±45		deg	
High level pulse width	T <sub>H</sub>	450	-	700	μs	Test signal
Low level pulse width	$T_L$	500	-	750	μs	<ul><li>according to figure 1</li></ul>
High level output voltage	V <sub>OH</sub>	Vcc-0.4			V	I <sub>SOURCE</sub> ≦1μA
Low level output voltage	V <sub>OL</sub>		0.2	0.5	V	I <sub>SINK</sub> ≦2mA
Internal pull up resistor	$R_{PU}$	85	100	115	kΩ	



#### **Test method**

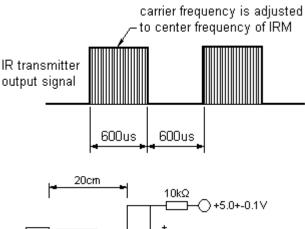
The specified electro-optical characteristics are valid under the following conditions.

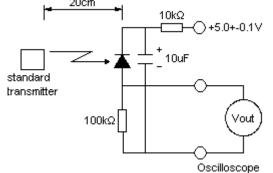
- 1. Measurement environment
  - A place without extreme light reflections.
- 2. External light

The environment contains an ordinary, white fluorescent lamp without high frequency modulation. The color temperature is 2856K and the illumination at the IR receiver is less than 10 Lux ( $Ev \le 10$ Lux).

- 3. Standard transmitter
  - The test transmitter is calibrated by using the circuit shown in figure 2. The radiation intensity of the transmitter is adjusted until **Vo=400mVp-p.** Both, the test transmitter and the photo diode, have a peak wavelength of 940nm. The photo diode for calibration is PD438B (λp=940nm, Vr=5V).
- 4. The measurement system is shown in Fig.-3

Fig.-1 Transmitter Wave Form





D.U.T output Pulse

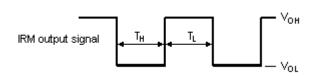
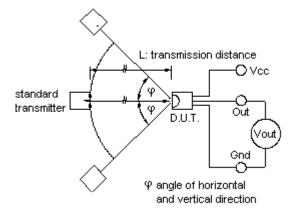
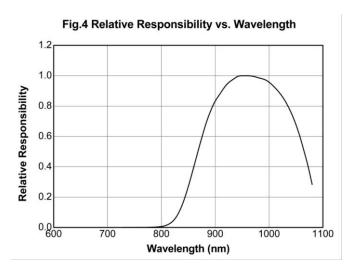


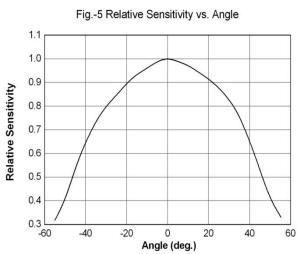
Fig.-3 Measuring System

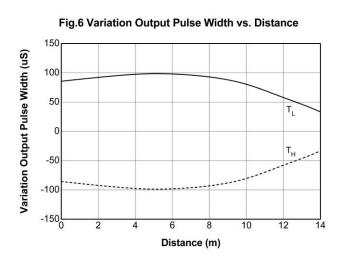




# **Typical Electro-Optical Characteristics Curves**







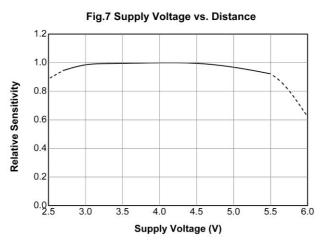
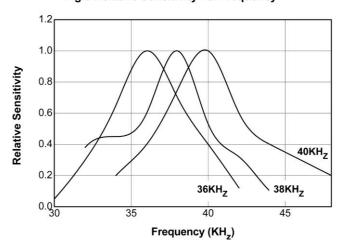
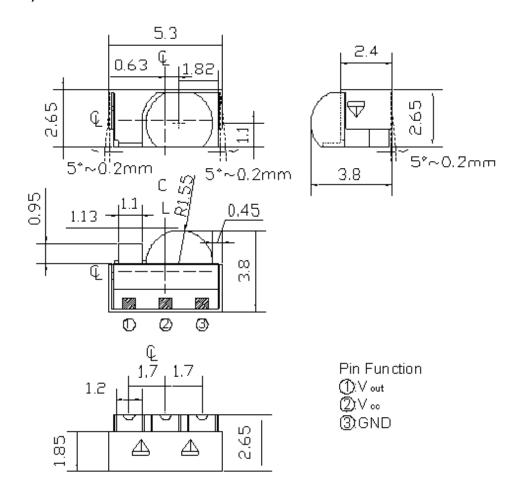


Fig.8 Relative Sensitivity vs. Frequency

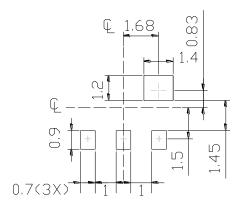




# Package Dimension (Dimensions in mm)



Note :Tolerances unless dimensions  $\pm\,0.5$  mm. Recommended pad layout for surface mount leadform

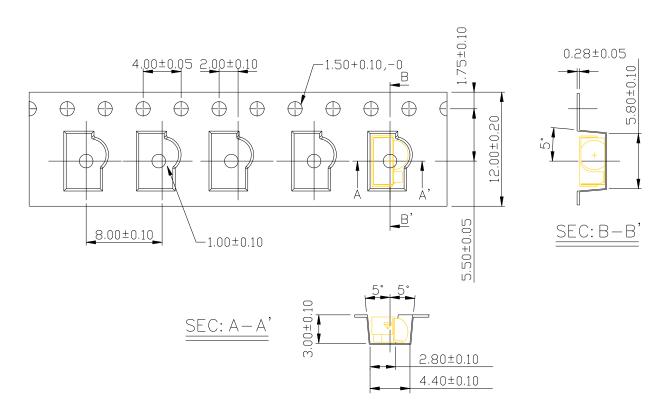




## **Code information**

Protocol	Suitable	Protocol	Suitable
JVC	Yes	RCA	Yes
Matsushita	Yes	Sharp	Yes
Mitsubishi	Yes	Sony 12 Bit	Yes
NEC	Yes	Sony 15 Bit	Yes
RC5	Yes	Sony 20Bit	Yes
RC6	Yes	Toshiba	Yes
RCMM	No	Zenith	Yes
RCS-80	No	Continuous Code	No

**Tape & Reel Packing Specifications** (Dimensions in mm)

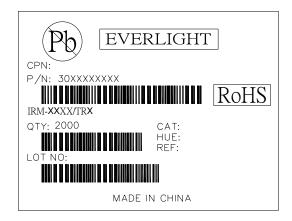


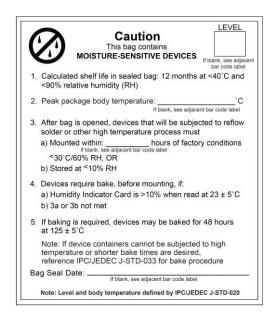
# **Packing Quantity**

2000 pcs / Reel 5 Reels / Carton



#### **Label format**





Moisture Classification-storage and used condition label

# Recommended method of storage

The following are general recommendations for moisture sensitive level (MSL) 4 storage and use:

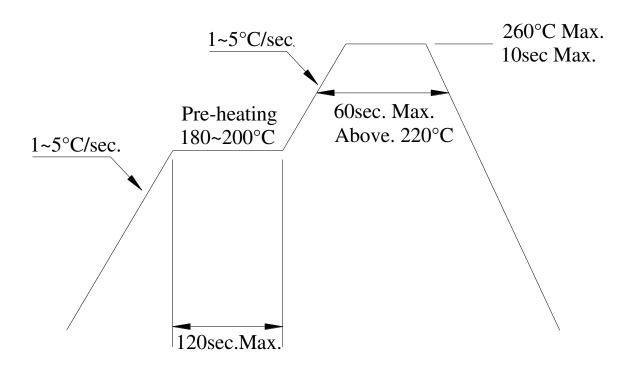
- 1. Shelf life in sealed bag from the bag seal date: 12 months at < 40 °C and < 90% relative humidity (RH)
- 2. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must mounted within 72 hours of factory conditions < 30 °C/60%RH.
- If the moisture absorbent material (silica gel) has faded away or the IRM has exceeded the storage time. Baking treatment is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the conditions: 60±5°C for 96 hours.

#### **ESD Precaution**

Proper storage and handing procedures should be followed to prevent ESD damage to the devices especially when they are removed from the Anti-static bag. Electro-Static Sensitive Devices warning labels are on the packing.



## **Solder Reflow Temperature Profile**



#### Note:

- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the IRM device during heating.
- 3. After soldering, do not warp the circuit board.

#### **Application Restrictions**

- 1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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